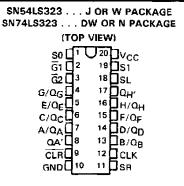
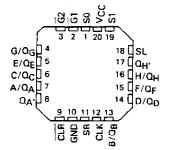
OCTOBER 1976 - REVISED MARCH 1988

- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operation:
 Hold (Store) Shift Left
 Shift Right
 Load Data
- · Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Typical Power Dissipation . . . 175 mW
- Exceptionally Stable Shift (Clock)
 Frequency . . . 25 MHz
- Applications: Stacked or Push-Down Registers, Buffer Storage, and Accumulator Registers
- SN54LS299 and SN74LS299 Are Similar But Have Direct Overriding Clear



SN54LS323 . . . FK PACKAGE (TOP VIEW)



description

These Low-Power Schottky eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table. Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. The clear function is synchronous, and a low-level at the clear input clears the register on the next low-to-high transition of the clock.

FUNCTION TABLE

MODE	INPUTS							INPUTS/OUTPUTS						OUTPUTS				
	CLR	FUNCTION SELECT		CONTROL		CLK	SERIAL		A/Q _A	B/Qg	c/ac	o/Qp	E/QE	F/Q _F	G/Qc	Н/Он	Q _A ,	OH.
		S1	S0	Ğ1 [†]	G2†		SL	SR	·	_	•	_	-	•	_	•	~	••
Clear	L	х	L	L.	7	Ť	×	Х		L,	Ļ		L	L	L	<u> </u>	L	L
	Ļ	L	×	L	L	†	×	×	L.	L	L	L	L	L	L	L	L	L
	L	Н	н	х	х	†	x	х	х	х	×	х	×	x	×	×	L	Ĺ
Hold	н	L	L	L	٦	×	X	х	QAO	QBQ	QC0	000	Q _{EO}	Q _{FQ}	α_{G0}	Q _{H0}	Q _{A0}	ано
	н	×	X	L	L	L	×	x	QAO		aco	a _{D0}	Œ0	GE0			QAO	QHO
Shift Right	Н	L	Н	L	Ļ	Ť	X	Ĥ	Н	QAn	OB n	Q _{Cn}	Qpn	űe,	Q _{En}	Q_{G_0}	Н	QGo
	Н	L	H	ĹĿ.	L	†	×	L	L	a_{An}	Qen	a_{Cn}	a_{Dn}	α_{En}	\mathbf{q}_{Fn}	o _{G⊓}	L	α_{Gn}
Shift Left	н	Н	L	L	L	t	н	Х	QBn	аcп	αpn	QEn	Q _{En}	QGn	QHn	Н	QBn	H
	Н	Н	L	L	L.	1	L	X	QBn	a_{Cn}	αpn	ι	a_{Fn}	a_{Gn}	Q _{Hn}	L	QBn	L
Load	H	Н	Н	×	×	†	×	×	a	ь	C	d	e	_ 	9	ħ	a	h

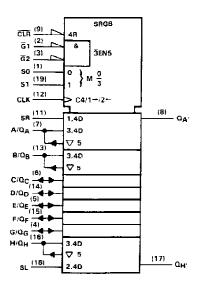
[†]When one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

a...h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.



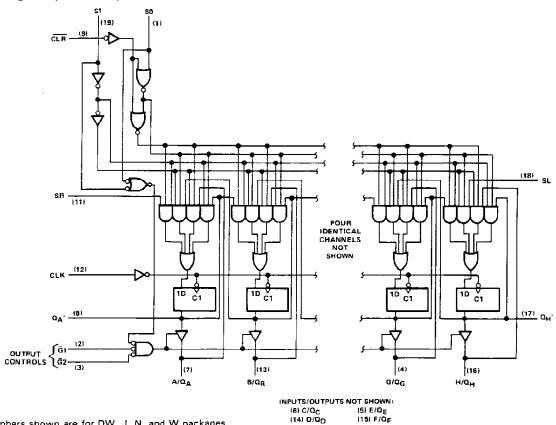
SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)



Pin numbers shown are for DW, J, N, and W packages.



schematics of inputs and outputs, absolute maximum ratings, recommended operating conditions, and electrical characteristics

Same as SN54LS299 and SN74LS299, except t_{SU} (Clear Inactive) does not apply.

switching characteristics, VCC = 5 V, $T_A = 25^{\circ}$ C

PARAMETER †	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN 25	TYP 35	MAX	UNIT
f _{max}			See Note 1				
^t PLH	CLK	QA' or QH'	C = 15 = 5		22	33	ns
[‡] PHL	CER	QA OI QH	C _L = 15 pF, R _L = 2 kΩ		26	39	
^t PLH	CLK	Q _A thru Q _H		1	17	25	ns
^t PHL	GER	MA IIII CH	C - 45 - C - C - C - C		25	39	
^t PZH	<u>G</u> 1, <u>G</u> 2	Q _A thru Q _H	CL = 45 pF, R _L = 665 Ω		14	21	ns
tPZL	41, 42	CA till CA			20	30	
^t PHZ	Ğ1, Ğ2	Q _A thru Q _H	C E - B BEE D		10	20	
tPLZ_		αχ tina α _H	CL=5pF, RL=665Ω		10	15	пs

 $^{^{\}dagger}$ t_{max} = maximum clock frequency

tp_H = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

tpzH = Output enable time to high level

tpzL = Output enable time to low level

tpHZ = Output disable time from high level

tpLZ = Output disable time from low level

NOTE 1: For testing f_{max}, all outputs are loaded simultaneously, each with C_L and R_L as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.

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